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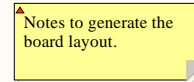
- Sheet 1: Project overview (this page)
- Sheet 2: MB1329_Top
- Sheet 3: modem
- Sheet 4: SIM
- Sheet 5: Stmod
- Sheet 6: Power

Legend

General comment such as function title, configuration, ...

Text to be added to silkscreen.

Warning text.



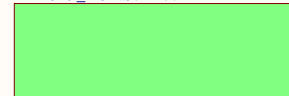
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U_MB1329_TOP
MB1329_TOP.SchDoc



Title: Project overview		
Project: C2C		
Variant: [No Variations]		
Revision: B-03		Reference: MB1329
Size: A4	Date: 01-JAN-16	Sheet: 1 of 6

